1. A method of making a sensor to measure an analyte in a solution, the method comprising: providing a substrate; printing conductive ink on the substrate to form a plurality of electrode regions; depositing an electrical insulation to cover one of the electrode regions; sonically ablating the electrical insulation to form an array of pores through the electrical insulation to the conductive ink in the one electrode region; and

depositing metal into the pores to form an array of electrodes in the one electrode region.

2. The method of claim 1 wherein depositing the metal comprises depositing gold.

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- 3. The method of claim 1 wherein depositing the metal comprises depositing platinum.
- 4. The method of claim 1 wherein depositing the metal comprises depositing chromium.
- 5. The method of claim 1 wherein depositing the metal comprises depositing nickel.
 - 6. The method of claim 1 wherein depositing the metal comprises depositing cadmium.
 - 7. The method of claim 1 wherein depositing the metal comprises depositing copper.
 - 8. The method of claim 1 wherein depositing the metal comprises depositing layers of different metals.

- 9. The method of claim 1 wherein depositing the metal comprises depositing a first layer of chromium and a second layer of gold over the chromium.
- 10. The method of claim 1 wherein depositing the metal comprises depositing a first layer of gold and a second layer of mercury over the gold.
- 11. The method of claim 1 further comprising treating the metal with a chemical solution to modify characteristics of the array of electrodes.
- 10 12. The method of claim 1 further comprising treating the metal with a thiol solution.

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| 13. A sensor to measure an analyte in a solution comprising. |
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| a substrate; |
| a plurality of electrode regions comprising conductive ink printed on the substrate; |
| electrical insulation deposited over one of the electrode regions; and |
| an array of electrodes in the one electrode region comprising metal deposited in an array |
| of pores sonically ablated through the electrical insulation to the conductive ink. |
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| 14. The sensor of claim 13 wherein the metal comprises gold. |
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| 15. The sensor of claim 13 wherein the metal comprises platinum. |
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| 16. The sensor of claim 13 wherein the metal comprises chromium. |
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| 17. The sensor of claim 13 wherein the metal comprises nickel. |
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| 18. The sensor of claim 13 wherein the metal comprises cadmium. |
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| 19. The sensor of claim 13 wherein the metal comprises copper. |
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| 20. The sensor of claim 13 wherein the metal comprises layers of different metals. |
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| 21. The sensor of claim 13 wherein the metal comprises a first layer of chromium and a second |
| layer of gold over the chromium. |

- 22. The sensor of claim 13 wherein the metal comprises a first layer of gold and a second layer of mercury over the gold.
- 5 23. The sensor of claim 13 wherein the metal is treated with a chemical solution to modify characteristics of the array of electrodes.
 - 24. The sensor of claim 13 wherein the metal is treated with a with a thiol solution.